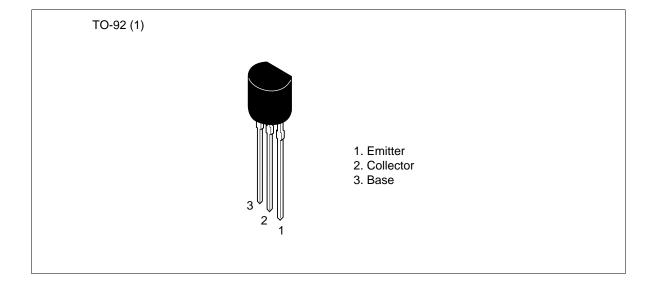
# Silicon NPN Epitaxial

# **HITACHI**

#### **Application**

- Low frequency low noise amplifier
- Complementary pair with 2SA872/A

#### **Outline**





#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

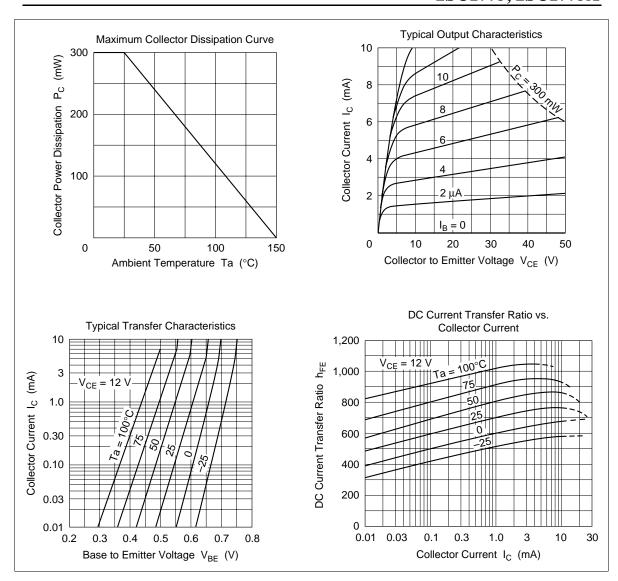
Item	Symbol	2SC1775	2SC1775A	Unit
Collector to base voltage	$V_{CBO}$	90	120	V
Collector to emitter voltage	V <sub>CEO</sub>	90	120	V
Emitter to base voltage	$V_{EBO}$	5	5	V
Collector current	I <sub>c</sub>	50	50	mA
Collector power dissipation	P <sub>c</sub>	300	300	mW
Junction temperature	Tj	150	150	°C
Storage temperature	Tstg	-55 to +150	-50 to +150	°C

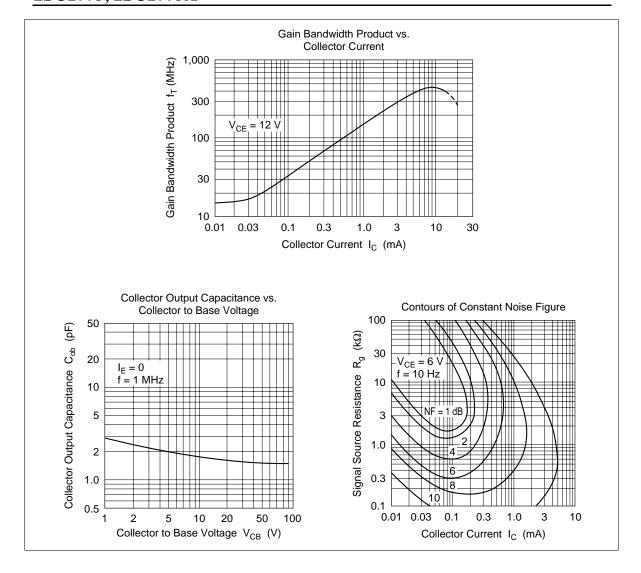
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

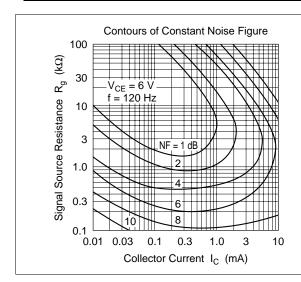
		2SC1	775		2SC1775A					
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Unit	Test condition	าร
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	90	_	_	120	_	_	V	$I_{\rm C}$ = 1 mA, $R_{\rm BE}$	= ∞
Collector cutoff current	I <sub>CBO</sub>	_	_	0.5	_	_	_	μΑ	$V_{CB} = 75 \text{ V}, I_{E} = 0$	
		_	_	_	_	_	0.5	μΑ	$V_{CB} = 100 \text{ V}, I_{E}$	= 0
DC current transfer ratio	h <sub>FE1</sub> *1	400	_	1200	400	_	1200		$V_{CE} = 12 \text{ V}, I_{C} =$	= 2 mA
	h <sub>FE2</sub>	160	_	_	160	_	_		$V_{CE} = 12 \text{ V},$ $I_C = 0.1 \text{ mA}$	
Base to emitter voltage	V <sub>BE</sub>	_	_	0.75	_	_	0.75	V	V <sub>CE</sub> = 12 V, I <sub>C</sub> =	= 2 mA
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	0.5	_	_	0.5	V	$I_C = 10 \text{ mA}, I_B =$	= 1 mA
Gain bandwidth product	f <sub>T</sub>	_	200	_	_	200	_	MHz	V <sub>CE</sub> = 12 V, I <sub>C</sub> =	= 2 mA
Collector output capacitance	Cob	_	1.6	_	_	1.6	_	pF	$V_{CB} = 25 \text{ V}, I_{E} = f = 1 \text{ MHz}$	= 0,
Noise figure	NF	_	_	5.0	_	_	5.0	dB	$V_{CE} = 6 \text{ V},$ $I_{C} = 50  \mu\text{A},$ $R_{g} = 50  k\Omega$	f = 10 Hz
			_	1.5			1.5	dB		f = 1 kHz

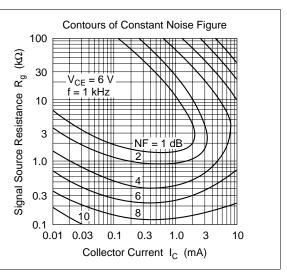
Note: 1. The 2SC1775/A is grouped by h<sub>FE1</sub> as follows.

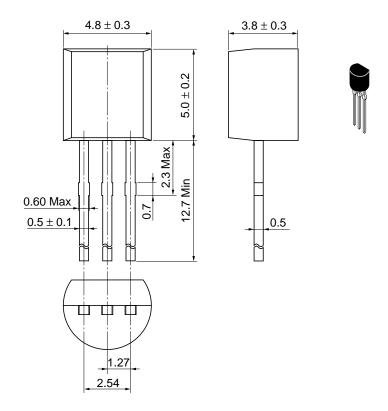
**E F** 400 to 800 600 to 1200











Hitachi Code	TO-92 (1)
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.25 g

#### **Cautions**

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